



■ Applications

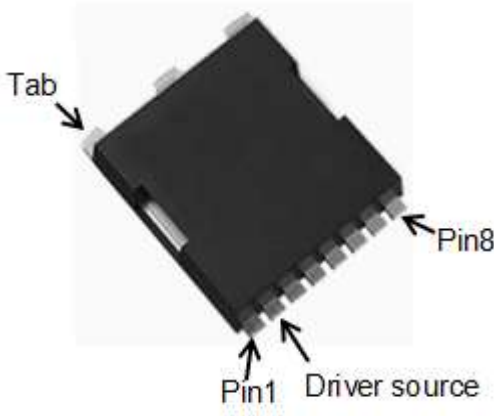
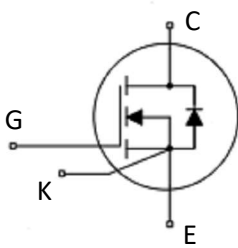
- Industrial UPS
- Welding machine
- Solar converters
- Energy Storage
- Mid to high range switching frequency converters

■ Features

- Low switching power loss
- Low switching surge and noise
- Advanced Fieldstop technology
- Low EMI
- Maximum junction temperature 175°C
- Short circuit withstand time – 5uS
- Qualified according to JEDEC for target applications
- RoHS and Halogen-Free Compliant

■ Product Summary

$V_{CES}$	650	V
$I_C$	75	A
$V_{CE(sat), Typ@15V}$	1.8	V

**TOLL**

Gate: Pin1  
 Collector: Tab  
 Emitter: Pin3~8  
 Driver Source: Pin2

Marking	Package	Packaging	Min. package quantity
MTB75N065J2S	TOLL	Tape & Reel	2000





### ■ Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Parameter	Symbol	Ratings	Unit
Collector-emitter Voltage	$V_{CES}$	650	V
DC collector current, limited by $T_{jmax}$ Tc=25°C Tc=100°C	$I_C$	90 75	A
Pulsed collector current, tp limited by $T_{jmax}$	$I_{C\ Pulse}$	225	A
Diode forward current, limited by $T_{jmax}$ Tc=25°C Tc=150°C	$I_F$	55 20	A
Diode Pulsed current, tp limited by $T_{jmax}$	$I_{F\ Pulse}$	160	A
Continuous Gate-emitter voltage	$V_{GE}$	±20	V
Power Dissipation (Tc=25°C)	$P_D$	400	W
Short circuit withstand time $V_{GE}=15V, V_{CC} \leq 400V, T_j \leq 150^\circ C$	$t_{SC}$	5	µs
Junction Temperature	$T_j$	175	°C
Storage Temperature	$T_{STG}$	-55-150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

### ■ Thermal Characteristics

Parameter	Symbol	Max	Unit
IGBT Maximum Junction-to-Case	$R_{\theta JC}$	0.38	°C/W
Diode Maximum Junction-to-Case	$R_{\theta JC}$	0.45	°C/W
Maximum Junction-to-Ambient	$R_{\theta JA}$	40	°C/W

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.





### ■ Electrical Characteristics (Tc=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{CES}$	$V_{GE}=0V, I_C=250\mu A$	650	-	-	V
Zero gate voltage collector current	$I_{CES}$	$V_{CE}=650V, V_{GE}=0V$	-	-	20	$\mu A$
Gate-emitter leakage current	$I_{GES}$	$V_{GE}=\pm 20V, V_{CE}=0V$	-	-	$\pm 100$	nA
Gate-emitter threshold voltage	$V_{GE(TH)}$	$V_{CE}=V_{GE}, I_C=250\mu A$	4	5	6	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=75A$	-	1.8	2.1	V
		$T_j=175^\circ C$	-	2.3	-	V
Diode forward voltage	$V_F$	$I_F=30A$	-	1.65	2.3	V
		$T_j=175^\circ C$	-	2.2	-	V
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{ies}$	$V_{CE}=25V, V_{GE}=0V,$ $f=500KHz$	-	4.55	-	nF
Output Capacitance	$C_{oes}$		-	240	-	pF
Reverse Transfer Capacitance	$C_{res}$		-	70	-	pF
Integrated gate resistor	$R_{Gint}$		-	3.2	-	$\Omega$
Total Gate Charge	$Q_g$	$V_{CC}=400V, I_C=25A,$ $V_{GE}=15V$	-	160	-	nC
Gate-to-emitter charge	$Q_{ge}$		-	20	-	nC
Gate-to-collector charge	$Q_{gc}$		-	65	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	$L_E$		-	2	-	nH





### ■ Switching Characteristic, Inductive Load, at $T_j=25^\circ\text{C}$

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>IGBT Switching Characteristics</b>						
Turn-On Delay Time	$t_{d(on)}$	$V_{CC}= 400\text{V}$ $I_C= 75\text{A}$ $V_{GE}= 15\text{V}$ $R_G= 10\Omega$ Inductive load	-	60	-	ns
Turn-On Rise Time	$t_r$		-	40	-	ns
Turn-Off Delay Time	$t_{d(off)}$		-	180	-	ns
Turn-Off Fall Time	$t_f$		-	32	-	ns
Turn-on energy	$E_{on}$		-	0.95	-	mJ
Turn-off energy	$E_{off}$		-	0.48	-	mJ
<b>Diode Characteristics</b>						
Reverse Recovery Time	$t_{rr}$	$V_R=400\text{V}, I_F=30\text{A},$ $di/dt=1000\text{A/us}$	-	30	-	ns
Reverse Recovery Charge	$Q_{rr}$		-	0.27	-	$\mu\text{C}$
Peak Reverse Recovery Current	$I_{rrm}$		-	18	-	A

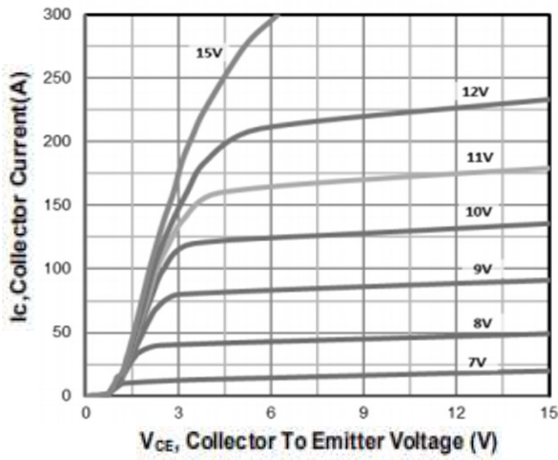
### ■ Switching Characteristic, Inductive Load, at $T_j=150^\circ\text{C}$

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>IGBT Switching Characteristics</b>						
Turn-On Delay Time	$t_{d(on)}$	$V_{CC}= 400\text{V}$ $I_C= 75\text{A}$ $V_{GE}= 15\text{V}$ $R_G= 10\Omega$ Inductive load	-	62	-	ns
Turn-On Rise Time	$t_r$		-	48	-	ns
Turn-Off Delay Time	$t_{d(off)}$		-	193	-	ns
Turn-Off Fall Time	$t_f$		-	75	-	ns
Turn-on energy	$E_{on}$		-	1.45	-	mJ
Turn-off energy	$E_{off}$		-	0.72	-	mJ
<b>Diode Characteristics</b>						
Reverse Recovery Time	$t_{rr}$	$V_R=400\text{V}, I_F=30\text{A},$ $di/dt=1000\text{A/us}$	-	40	-	ns
Reverse Recovery Charge	$Q_{rr}$		-	0.5	-	$\mu\text{C}$
Peak Reverse Recovery Current	$I_{rrm}$		-	25	-	A

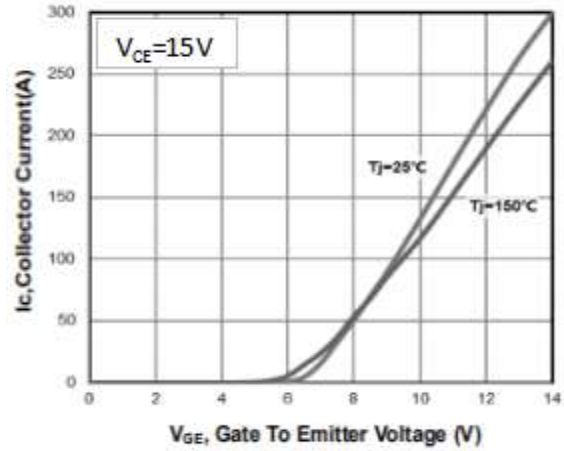




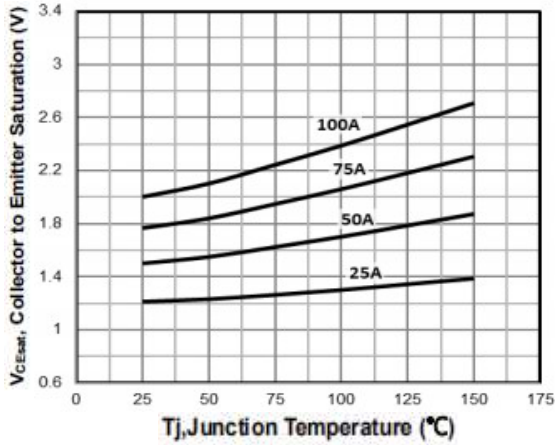
■ Characteristics Curves



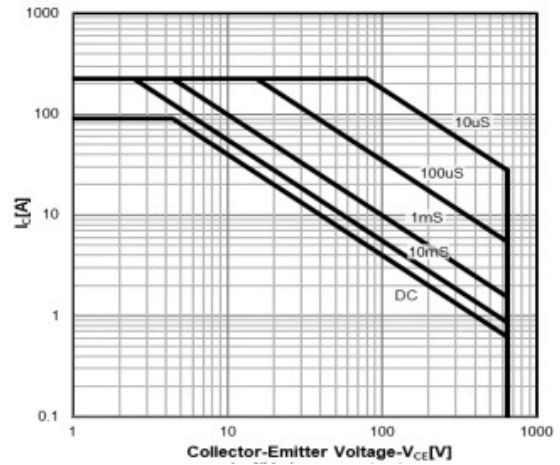
Output Characterisics



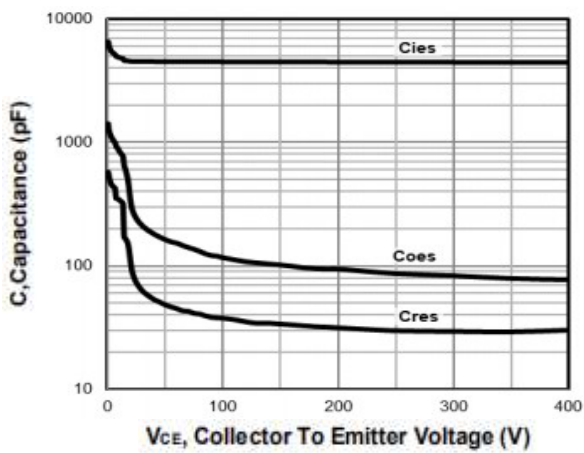
Transfer Characterisics



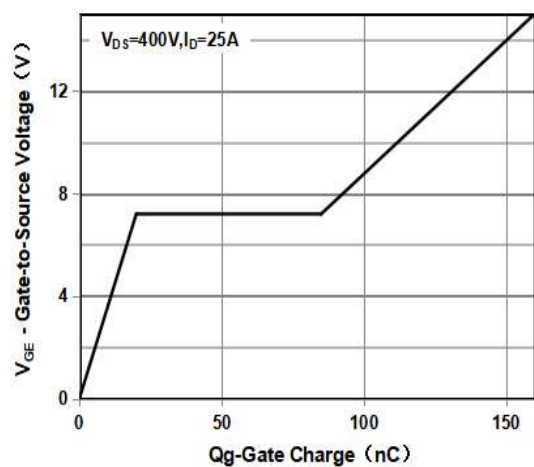
Typical collector-emitter saturation voltage as a function of junction temperature ( $V_{GE} = 15V$ )



Safe operating area

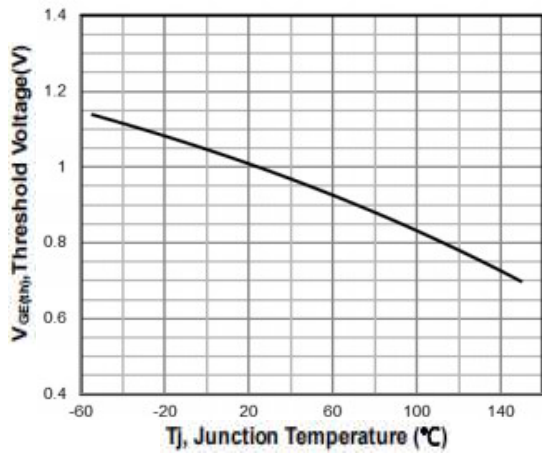


Capacitance

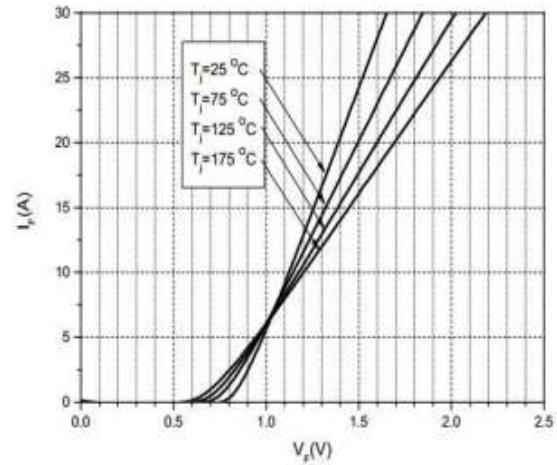


Typical gate charge





Gate-emitter threshold voltage as a function of junction temperature



Typ. diode forward current as a function of forward voltage

Note : The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.





■ TOLL Package Dimensions

Unit: mm

Symbol	Min	Nom	Max	Symbol	Min	Nom	Max
A	2.25	2.3	2.35	e1		1.225	
A1	1.75	1.8	1.85	E	9.85	9.9	9.95
b	0.65	0.7	0.75	E1	8	8.1	8.2
b1	9.75	9.8	9.85	H	11.6	11.7	11.8
b2	0.7	0.75	0.8	H1		6.95	
c	0.45	0.5	0.55	K		3.1	
D	10.35	10.4	10.45	L	1.55	1.65	1.75
D1	11	11.1	11.2	L1	0.65	0.7	0.75
D2	3.25	3.3	3.35	L2	0.5	0.6	0.7
D4	4.5	4.55	4.6	Q		6.75	
e		1.2		$\theta$		10°	

